

SIMATIC IPC847D (Rack PC) (Rack PC, 19", 4HU); 2x Gbit Ethernet (IE/PN), RJ45; 1x DVI-I; 2x display ports; 1x COM 1; 2x PS/2; audio; 4x USB 3.0 incl. 1x internal; 3x USB 2.0; Temp. and fan monitoring; Watchdog, Card retainer XEON E3-1275 V3 (4C/8T, 3.5 (3.9) GHz, 8 MB cache, TB, VT-D, AMT); mainboard without fieldbus RAID1, 240 GB (2x 240 GB SSD SATA mirror disks), in removable frame, hot swap; front-side 16 GB DDR3 SD-RAM (2x 8 GB), ECC, Dual channel Bus module 11 slots: 7X PCI, 3x PCIE X4, 1x PCIE X16; DVD +/-RW (SLIM) COM2; LPT (1 slot occupied) +PCle x16 graphics card (dual head: 2x VGA or 2x DVI-D), 1 GB, (1 slot occupied) Windows 10 Enterprise 2016 LTSB, MUI (en/de/fr/it/es), 64 bit for Xeon SIMATIC PC DiagMonitor V5.0 and Image&Partition Creator V3.5 enclosed 110/240V industrial power supply unit; with NAMUR, without line cable

Installation type/mounting	
Mounting	For horizontal and vertical installation; prepared for telescopic rails; 19" mounting bracket can be removed externally; tower kit (optional)
Design	Rack PC, 19", 4U
Supply voltage	
Type of supply voltage	100/240 V AC (autorange) 50 / 60 Hz; optional redundant 100/240 V AC; optional 100/240 V AC with UPS functionality incl. maintenance-free lead-tin battery
Line frequency	
• Rated value 50 Hz	Yes
• Rated value 60 Hz	Yes
Mains buffering	
• Mains/voltage failure stored energy time	20 ms
Processor	
Processor type	Xeon E3-1275 v3 (4C/8T, 3.5 (3.9) GHz, 8 MB cache); Xeon E3-1268L v3 (4C/8T, 2.3 (3.3) GHz, 8 MB cache); Core i5-4570TE (2C/4T, 2.7 (3.3) GHz, 4 MB cache); Core i3-4330TE (2C/4T, 2.4 GHz, 4 MB cache)
Chipset	Intel DH82C226 PCH
Graphic	
Graphics controller	Onboard graphics controller Intel HD 4600 Graphics integrated into the processor / PCI-Express graphics card (Dual Head: 2x VGA or 2x DVI-D) in the PCIe (x16) slot (optional)
Drives	
Optical drives	DVD±R/RW (SlimLine)
Hard disk	500 GB HDD, 1 TB HDD, 2x 1 TB HDD, RAID1 (2x 1 TB HDD, mirror disks), RAID1 (2x 1 TB HDD, mirror disks) + 1x 1 TB HDD as hot spare, RAID5 (3x 1 TB HDD, striping with parity), RAID5 (3x 1 TB HDD, striping with parity) + 1x 1 TB HDD as hot spare; RAID1 (2x 1 TB HDD SAS, mirror disks), RAID5 (3x 1 TB HDD SAS, striping with parity), RAID5 (3x 1 TB HDD SAS, striping with parity) + 1x 1 TB HDD SAS as hot spare incl. PCIe (x8) RAID SAS controller incl. ZMCP module
SSD	Yes; 240 GB SSD; RAID1 (2x 240 GB SSD, mirror disks)
Slot for drives	Mounted internally on the fixed hard disk support, or mounted internally in vibration/shock-absorbing hard disk support, or mounted at the front in the low-profile removable drive bay (hot-swap in RAID configurations)
Memory	
Main memory	2 GB to 32 GB DDR3-1600 DIMM, ECC optional
Capacity of main memory, max.	32 Gbyte
Hardware configuration	
Slots	
• free slots	11 slots: 7x PCI, 3x PCle (x4) (1 lane), 1x PCle (x16) or 3x PCI, 5x PCle mech. (x16) (4x 4 lanes, 1x 8 lanes), 3x PCle (x4); all modules to a length of 312 mm can be used
Interfaces	
Interfaces/bus type	1x COM1, 1x COM2 (optional), 1x LPT (optional), 2x DisplayPort, 1x

	DVI-I, 2x PS/2, audio (Microphone In, Line Out), 7x USB, 2x Gigabit Ethernet, PROFIBUS or PROFINET optional
PROFIBUS/MPI	optionally onboard, isolated, max. 12 Mbit/s, no plug-in card necessary, CP 5622-compatible
USB port	2x USB 3.0, 2x USB 2.0 rear, 1x USB 3.0, 1x USB 2.0 front, 1x USB 3.0 internal
Connection for keyboard/mouse	2x PS/2
serial interface	COM1: 1x RS 232, COM2 (optional): 1x RS 232
parallel interface	optional LPT1
Multimedia	
• Audio In/Out	Yes
• Microphone In	Yes
Video interfaces	
• Graphics interface	2x DisplayPort and 1x DVI-I onboard; 1x VGA via DVI-VGA adapter cable (optional); graphics card PCIe (x16), Dual Head (2x VGA or 2x DVI-D), 1 GB graphics memory (optional)
Industrial Ethernet	
• Industrial Ethernet interface	2x Ethernet (RJ45)
— 100 Mbps	Yes
— 1000 Mbps	Yes
Integrated Functions	
Monitoring functions	
• Temperature monitoring	Yes
• Watchdog	Yes
• Status LEDs	POWER, ETHERNET 1, ETHERNET 2, PN MPI / DP, WATCHDOG, TEMP, FAN, HDD0 ALARM, HDD1 ALARM, HDD2 ALARM, HDD HDD3 ALARM
• Fan	Yes
• Monitoring function via network	Optional
EMC	
Interference immunity against discharge of static electricity	
• Interference immunity against discharge of static electricity	±6 kV contact discharge acc. to IEC 61000-4-2; ±8 kV air discharge acc. to IEC 61000-4-2
Interference immunity against high-frequency electromagnetic fields	
• Interference immunity against high frequency radiation	10 V/m for 80 - 1 000 MHz and 1.4 - 2 GHz, 80% AM acc. to IEC 61000-4-3; 3 V/m for 2 - 2.7 GHz, 80% AM acc. to IEC 61000-4-3; 10 V for 10 kHz - 80 MHz, 80% AM acc. to IEC 61000-4-6
Interference immunity to cable-borne interference	
• Interference immunity on supply cables	±2 kV acc. to IEC 61000-4-4, burst; ±1 kV acc. to IEC 61000-4-5, surge symmetric; ±2 kV acc. to IEC 61000-4-5, surge asymmetric
• Interference immunity on signal cables >30m	±2 kV acc. to IEC 61000-4-4, burst; ±2 kV acc. to IEC 61000-4-5, surge
• Interference immunity on signal cables < 30m	±1 kV acc. to IEC 61000-4-4, Burst
Interference immunity against voltage surge	
• asymmetric interference	±2 kV acc. to IEC 61000-4-5, surge asymmetric
• symmetric interference	±1 kV acc. to IEC 61000-4-5, surge symmetric
Interference immunity to magnetic fields	
• Interference immunity to magnetic fields at 50 Hz	100 A/m; to IEC 61000-4-8
Emission of conducted and non-conducted interference	
• Interference emission via line/AC current cables	EN 61000-6-3, FCC Class A, EN 61000-6-4, CISPR 22, EN 55022 Class B, EN 61000-3-2 Class D, EN 61000-3-3
Degree and class of protection	
IP degree of protection	IP20
IP (at the front)	IP41
IP (rear)	IP20
Standards, approvals, certificates	
CE mark	Yes; For use in industrial areas as well as domestic, business and commercial environments (emitted interference: EN 61000-6-3:2007 +A1:2011, noise immunity: EN 61000-6-2:2005)
CSA approval	Yes; Included in cULus
UL approval	Yes
cULus	Yes; UL 60950-1, file number E115352
RCM (formerly C-TICK)	Yes
KC approval	Yes

EAC (formerly Gost-R)	Yes
EMC	CE, EN 61000-6-3:2007 +A1:2011, EN 61000-6-2:2005
Dust protection	With front door closed: G2 EN 779, 99% of particles > 0.5 mm are filtered
Ambient conditions	
Ambient temperature during operation	
Ambient temperature during operation	0 °C to +45 °C, no burner operation, 0 °C to +50 °C, no operation of optical drive, power dissipation of the expansion cards in total < 30 W, maximum 3 removable drive bays, 0 °C to +40 °C with AC UPS, 0 °C to +35 °C with hardware RAID controller
Ambient temperature during storage/transportation	
- min. - max.	-20 °C 60 °C
Relative humidity	
Relative humidity	Tested according to IEC 60068-2-78, IEC 60068-2-30: Operation: 5% to 80% at 25 °C (no condensation), Storage: 5% to 95% at 25 °C (no condensation)
Vibrations	
Vibration resistance during operation acc. to IEC 60068-2-6	tested according to DIN IEC 60068-2-6: 10 Hz to 58 Hz: 0.0375 mm, 58 Hz to 500 Hz: 4.9 m/s ² (0.5 g)
Shock testing	
Shock load during operation	Tested according to IEC 60068-2-27, IEC 60068-2-29: half-sine: 50 m/s ² (5 g), 30 ms, 100 shocks per axis
Operating systems	
pre-installed operating system	Windows 7 Ultimate, multi-language (32-bit/64-bit), Windows 10 Enterprise 2015 LTSC, multi-language (64-bit), Windows 10 Enterprise 2016 LTSC, multi-language (64-bit), Windows Server 2008 R2 Standard Edition incl. 5 clients, multi-language (64-bit); Windows Server 2012 R2 Standard Edition incl. 5 clients, multi-language (64-bit); Windows Server 2016 Standard Edition incl. 5 clients, multi-language (64-bit)
Additional info on operating system	Multi-Language User Interface (MUI): 5 languages (English, German, French, Spanish, Italian)
without operating system	Yes
Software	
SIMATIC Software	Optionally in package with SIMATIC WinCC or WinCC flexible
Dimensions	
Width	430 mm
Height	177 mm; 4U
Depth	444 mm
last modified:	6/12/2021 